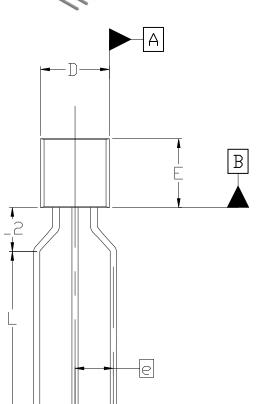




0.20(M)BAM

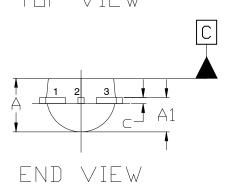
DATE 07 JAN 2021



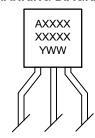
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, GATE REMAINS AND TIE BAR PROTRUSIONS.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	3.05	3.60	4.19	
A1	2.13	2.50	2.88	
b	0.36	0.46	0.56	
C	0.30	0.40	0.52	
D	4.32	4.75	5,20	
E	4.32	4.80	5,33	
е	2.54 BSC			
L	10.50	11.75	13.00	
L2	2.54		3,44	



GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code A = Assembly Location

Y = Year WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may

not follow the Generic Marking.

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DESCRIPTION:	TO-92 3LD 4.75X4.80		PAGE 1 OF 1

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